

IN THE CLAIMS:

Please cancel claims 11 and 15, and amend the claims as follows:

1. (Currently Amended) A method for repairing a memory device having at least one array of memory cells arranged in rows and columns with each row further divided into a plurality of words, the method comprising:

detecting defective storage cells;

conducting one of a column test and a row test comprising identifying and storing addresses of a respective one of columns and rows having one or more defective storage cells;

overwriting stored addresses of one of columns and rows having a first number of defective storage cells with addresses of one of columns and rows having a second number of defective storage cells, wherein the second number is greater than the first number;

replacing at least one of a row ~~or~~ and column having a stored address ~~containing one or more defective storage cells~~ with a redundant row or column; and thereafter

replacing at least one word containing one or more defective storage cells with a redundant word without replacing the entire row containing the at least one word.

2. (Original) The method of claim 1, further comprising allocating redundant rows or columns used for replacement among rows or columns, respectively, based on the number of defective storage cells contained therein.

3. (Original) The method of claim 2, comprising allocating a redundant row or column to a first row or column containing defective storage cells in preference over a second row or column containing a lesser number of defective storage cells.

4. (Original) The method of claim 3, further comprising replacing the defective storage cells of the second row or column with one or more redundant words.

5. (Original) The method of claim 4, wherein one redundant word replaces defective storage cells of at least two columns.
6. (Original) The method of claim 4, further comprising activating a FAIL signal to indicate the memory device is not repairable if all defective cells detected cannot be replaced.
7. (Original) The method of claim 1, wherein the method is performed as part of a built-in self test (BIST) of the memory device.
8. (Original) The method of claim 7, wherein the BIST serves multiple memory devices with embedded and shared redundant elements.
9. (Original) The method of claim 1, wherein detecting defective storage cells comprises conducting a column test.
10. (Original) The method of claim 9, wherein conducting the column test comprises identifying and storing addresses of columns having greater than a threshold number of defective storage cells.
11. (Cancelled)
12. (Original) The method of claim 9, wherein detecting defective storage cells comprises conducting a row test.
13. (Original) The method of claim 1, wherein detecting defective storage cells comprises conducting a row test.
14. (Currently Amended) The method of claim 13, wherein conducting the row test comprises identifying and storing addresses of rows having greater than a predefined threshold number of defective storage cells.
15. (Cancelled)
16. (Currently Amended) A self-repairing memory device comprising:

at least one array of storage cells arranged in columns and rows, with each row comprising multiple words;

at least one of redundant row or column elements for replacing rows or columns containing defective storage cells;

at least one block of redundant word elements for replacing words containing defective storage cells without replacing the entire rows containing the words being replaced; and

built-in self repair (BISR) circuitry configured to:

conduct one of a column test and a row test comprising identifying and storing addresses of respective one of columns and rows having one or more defective storage cells, and overwriting stored addresses of one of the columns and rows having a first number of defective storage cells with addresses of one of columns and rows having a second number of defective storage cells, wherein the second number is greater than the first number; and

replace at least one of a row ~~or~~ and column having a stored address containing one or more defective storage cells with a redundant row or column element and, after completion of the replacement of the at least one of a row ~~or~~ and column by the redundant row or column element, to replace at least one word containing one or more defective storage cells with a redundant word element without replacing the entire row containing the at least one word.

17. (Cancelled)

18. (Currently Amended) The self-repairing memory device of claim 47 16, wherein:

the built-in self repair (BISR) circuitry is configured to allocate redundant row or column elements to rows or columns containing defective storage cells based on the number of defective storage cells contained therein.

19. (Original) The self-repairing memory device of claim 18, wherein:

the built-in self repair (BISR) circuitry is configured to replace, with redundant word elements, defective storage cells contained in rows or columns not allocated redundant row or column elements.

20. (Original) The self-repairing memory device of claim 18, wherein:
the at least one array of storage cells comprises multiple arrays of storage cells;
and
at least two of the arrays of storage cells share the block of redundant word elements.

21. (Original) The self-repairing memory device of claim 18, wherein:
the at least one array of storage cells comprises multiple arrays of storage cells;
the at least one of redundant row or column elements for replacing rows or columns containing defective storage cells comprises redundant row elements and redundant column elements; and
each array of storage cells is provided with at least one BISR circuit.

22. (Original) The self-repairing memory device of claim 16, wherein the storage cells are dynamic storage cells.

23. (Original) The self-repairing memory device of claim 16, wherein the built-in self repair (BISR) circuitry comprises:
row test circuitry; and
a plurality of registers to store address of rows containing at least a first threshold number of defective memory cells, as detected by the row test circuitry.

24. (Original) The self-repairing memory device of claim 23, wherein the built-in self repair (BISR) circuitry further comprises:
column test circuitry; and
a plurality of registers to store address of columns containing at least a second threshold number of defective memory cells, as detected by the row test circuitry.

25. (Original) The self-repairing memory device of claim 16, wherein the built-in self repair (BISR) circuitry comprises:

column test circuitry; and

a plurality of registers to store address of columns containing at least a threshold number of defective memory cells, as detected by the column test circuitry.

26. (Currently Amended) The self-repairing memory device of claim 16, further comprising:

a bank of non-volatile storage elements to store addresses of at least one of rows or columns to be replaced with redundant rows or columns elements.

27. (Original) The self-repairing memory device of claim 16, further comprising a memory built-in self test (BIST) circuit to identify defective storage cells.

28-33. (Cancelled)

34. (Currently Amended) A memory built-in self repair device, comprising:

a plurality of memories, each of said memories having an array of storage cells arranged in columns and rows, with each row comprising multiple words,

a plurality of memory built-in self repair circuits, each memory built-in self repair circuit being associated to one of the plurality of memories and being configured to allocate at least one of redundant row elements and column elements for replacing respective one of rows and columns of the associated memory having defective storage cells, and

at least one block of redundant word elements for replacing words containing defective storage cells without replacing the entire rows containing the words being replaced, wherein one block of redundant word elements is used for replacing words containing defective storage cells of the plurality of memories, and wherein replacing of the at least one word with a redundant word is accomplished after replacement of all rows or columns with redundant rows or columns.

35. (Cancelled)

Please add the following new claims:

36. (New) A method for repairing a memory device having at least one array of memory cells arranged in rows and columns with each row further divided into a plurality of words, the method comprising:

detecting a defective storage cell;

conducting one of a column test and row test comprising identifying and storing addresses of respective one of columns and rows having greater than a predefined number of defective storage cells;

replacing at least one of a row and column having a stored address with a redundant row or column; and thereafter

replacing at least one word containing one or more defective storage cells with a redundant word without replacing the entire row containing the at least one word.

37. (New) A self repairing memory device, comprising:

at least one array of storage cells arranged in columns and rows, with each row comprising multiple words;

at least one or redundant row and column elements for replacing respective one or rows and columns comprising defective storage cells;

at least one block of redundant word elements for replacing words containing defective storage cells without replacing entire rows comprising the words being replaced; and

built in self repair (BISR) circuitry configured to:

conduct a column or row test comprising identifying and storing addresses of columns or rows having greater than a predefined number of defective storage cells; and

replace at least one of a row and a column having a stored address with a redundant row or column element and, after completion of the replacement of the at least one of the row and column by the redundant row or column element, replace at least one word containing one or more defective storage cells with a

redundant word element without replacing an entire row comprising the at least one word.